



# **Symbols**

### Arrangement of Symbols

### Letter symbols for current, voltage and power (according to DIN 41 785, sheet 1)

To represent current, voltage and power, a system of basic letter symbols are used. Capital letters are used for the representation of peak, mean, dc or rootmean-square values. Lower case letters are used for the representation of instantaneous values which vary with time.

Capital letters are used as subscripts to represent continuous or total values, while lower case letters are used to represent varying values.

The following table summarizes the rules given above.

Basic letter	
Upper-case	Upper-case
Instantaneous values which vary with time	Maximum (peak) average (mean) continuous (dc) or root- mean-square (RMS) values
Subscript(s)	
Upper-case	Upper-case
Varying component alone,i.e.,instantaneous, root-mean-square, maximum	Continuous (without signal) or total (instantaneous, average or maximum) values

### Letter symbols for impedance, admittances, two-port parameters etc.

or average values

For impedance, admittance, two-port parameters, etc., capital letters are used for the representation of external circuits of which the device is only a part.

Lower case letters are used for the representation of electrical parameters inherent in the device.

The rules are not valid for inductance and capacitance. Both these quantities are denoted with capital letters.

Capital letters are used as subscripts for the designation of static (dc) values, while lower case letters are used for the designation of small-signal values.

If more than one subscript is used ( $h_{FE}$ ,  $h_{fe}$ ), the letter symbols are either all capital or all lower case.

If the subscript has numeric (single, double, etc.) as well as letter symbol(s) (such as  $h_{21E}$  or  $h_{21e}$ ), the differentiation between static and small-signal value is made only by a subscript letter symbol.

Other quantities (values) which deviate from the above rules are given in the list of letter symbols.

The following table summarizes the rules given above.

Basic letter	
Upper-case	Upper-case
Electrical parameters inherent in the semiconductor devices except inductances and capacitances	Electrical parameters of external circuits and of circuits in which the semiconductor device forms only a part; all inductances and capacitances
Subscript(s)	
Upper-case	Upper-case
Small-signal values	Static (dc) values

#### Examples:

 $R_{G}$ Generator resistance

 $G_P$ Power gain

DC forward current transfer ratio in common emitter configuration

Parallel resistance, damping resistance  $r_P$ 

# Example for the use of Symbols

according to 41785 and IEC 148



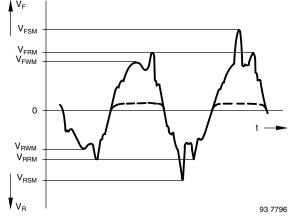


Figure 1.

٧F Forward voltage

Reverse voltage

V<sub>ESM</sub> Surge forward voltage (non-repetitive)

V<sub>RSM</sub> Surge reverse voltage (non-repetitive)

V<sub>FRM</sub> Repetitive peak forward voltage

V<sub>RRM</sub> Repetitive peak reverse voltage

V<sub>FWM</sub> Crest working forward voltage

V<sub>RWM</sub> Crest working reverse voltage

Document Number 84056 www.vishay.com Rev. 1.2, 20-Jan-04



# **Vishay Semiconductors**



# **List of Symbols**

A Anode

a Distance (in mm)

C Capacitance, general

C<sub>case</sub> Case capacitance

C<sub>D</sub> Diode capacitance

C<sub>i</sub> Junction capacitance

C<sub>L</sub> Load capacitance

C<sub>P</sub> Parallel capacitance

F Noise figure

f Frequency

f<sub>g</sub> Cut-off-frequency

I<sub>F</sub> Forward current

i<sub>F</sub> Forward current, instantaneous total value

I<sub>FAV</sub> Average forward current, rectified current

I<sub>FRM</sub> Repetitive peak forward current

I<sub>FSM</sub> Surge forward current, non-repetitive

I<sub>FWM</sub> Crest working forward current

I<sub>R</sub> Reverse current

i<sub>R</sub> Reverse current, instantaneous total value

IRAV Average reverse current

I<sub>RRM</sub> Repetitive peak reverse current

I<sub>RSM</sub> Non-repetitive peak reverse current

I<sub>RWM</sub> Crest working reverse current

I<sub>S</sub> Supply current

I<sub>Z</sub> Z-operating current

I<sub>ZM</sub> Z-maximum current

Length (in mm), (case-holder/soldering point)

LOCEP (local epitaxy)

A registrated trade mark of Vishay for a process ofepitaxial deposition on silicon. Applications occur in planer Z-diodes. It has an advantage compared to the normal process, with reduced reverse current.

P Power

Ptot Total power dissipation

P<sub>V</sub> Power dissipation, general

P<sub>vn</sub> Pulse-power dissipation

Q Quality

Q<sub>rr</sub> Reverse recovery charge

R<sub>F</sub> Forward resistance

r<sub>f</sub> Differential forward resistance

R<sub>I</sub> Load resistor

r<sub>P</sub> Parallel resistance, damping resistance

R<sub>R</sub> Reverse resistance

r<sub>r</sub> Differential reverse resistance

r<sub>s</sub> Series resistance

R<sub>thJA</sub> Thermal resistance between junction and

R<sub>th,IC</sub> Thermal reistance between junction and case

r<sub>z</sub> Differential Z-resistance in breakdown region

 $(range) r_z = r_{zi} + r_{zth}$ 

 $r_{zj}$  Z-resistance at constant junction temperature,

inherent Z-resistance

r<sub>zth</sub> Thermal part of the Z-resistance

T Temperature, measured in centigrade

T Absolute temperature, Kelvin temperature

T Period duration

T<sub>amb</sub> Ambient temperature (range)

T<sub>case</sub> Case temperature

t<sub>fr</sub> Forward recovery time

T<sub>i</sub> Junction temperature

T<sub>K</sub> Temperature coefficient

T<sub>L</sub> Connecting lead temperature in the holder (sol-

dering point) at the distance/(mm) from case

t<sub>P</sub> Pulse duration (time)

t<sub>p</sub>/T Duty cycle

t<sub>r</sub> Rise time

t<sub>rr</sub> Reverse recovery time

t<sub>s</sub> Storage time

T<sub>sd</sub> Soldering temperature

T<sub>stq</sub> Storage temperature (range)

V<sub>(BR</sub>) Breakdown voltage

V<sub>F</sub> Forward voltage

V<sub>F</sub> Forward voltage, instantaneous total value

V<sub>FAV</sub> Average forward voltage

V<sub>o</sub> Rectified voltage

V<sub>ESM</sub> Surge forward voltage, non-repetitive

V<sub>FRM</sub> Repetitive peak forward voltage

V<sub>FWM</sub> Crest working forward voltage

V<sub>B</sub> Reverse voltage

V<sub>R</sub> Reverse voltage, instantaneous total value

V<sub>RSM</sub> Surge reverse voltage, non-repetitive

V<sub>RRM</sub> Repetitive peak reverse voltage

V<sub>RWM</sub> Crest working reverse voltage

V<sub>Z</sub> Z-operating voltage

Z<sub>thp</sub> Thermal resistance – pulse operation

η<sub>r</sub> Rectification efficiency

ΔC<sub>D</sub> Capacitance deviation